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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/549,447	09/14/2005	Chiaki Sasaoka	029437-0111	5540
FOLEY AND LARDNER LLP SUITE 500			EXAMINER	
			ZHANG, YUANDA	
3000 K STREET NW WASHINGTON, DC 20007			ART UNIT	PAPER NUMBER
			2828	
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			MAIL DATE	DELIVERY MODE
			07/03/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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	Application No.	Applicant(s)			
	10/549,447	SASAOKA, CHIAKI			
Office Action Summary	Examiner	Art Unit			
	Yuanda Zhang	2828			
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet wi	th the correspondence address			
A SHORTENED STATUTORY PERIOD FOR REI WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNIO 1.136(a). In no event, however, may a riod will apply and will expire SIX (6) MON stute, cause the application to become AB	CATION. eply be timely filed ITHS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 14	4 September 2005.				
2a) ☐ This action is FINAL . 2b) ☑ T					
3) Since this application is in condition for allow	wance except for formal matt	ers, prosecution as to the merits is			
closed in accordance with the practice unde	er <i>Ex parte Quayle</i> , 1935 C.D	. 11, 453 O.G. 213.			
Disposition of Claims					
4)⊠ Claim(s) <u>1-6</u> is/are pending in the applicatio	n.				
4a) Of the above claim(s) 7-12 is/are withdra					
5) Claim(s) is/are allowed.		•			
6)⊠ Claim(s) <u>1-6</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and	d/or election requirement.				
Application Papers					
9) The specification is objected to by the Exam	iner.				
10)⊠ The drawing(s) filed on <u>14 September 2005</u>	is/are: a)⊠ accepted or b)[objected to by the Examiner.			
Applicant may not request that any objection to t	he drawing(s) be held in abeyar	nce. See 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the corr	rection is required if the drawing	(s) is objected to. See 37 CFR 1.121(d).			
11) ☐ The oath or declaration is objected to by the	Examiner. Note the attached	d Office Action or form PTO-152.			
Priority under 35 U.S.C. § 119	•				
12)⊠ Acknowledgment is made of a claim for fore a)⊠ All b)□ Some * c)□ None of:	ign priority under 35 U.S.C. §	3 119(a)-(d) or (f).			
1.⊠ Certified copies of the priority docume	ents have been received.				
2. Certified copies of the priority docume	ents have been received in A	pplication No			
Copies of the certified copies of the p	riority documents have been	received in this National Stage			
application from the International Bur	, , , ,				
* See the attached detailed Office action for a l	list of the certified copies not	received.			
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)		Summary (PTO-413) s)/Mail Date			
2)		nformal Patent Application			
Paper No(s)/Mail Date <u>09/14/05 and 12/15/06</u> .	6) 🔲 Other:	·			

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DETAILED ACTION

Priority

1. Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Information Disclosure Statement

2. The information disclosure statement (IDS) submitted on 09/14/05 and 12/15/06 is being considered by the examiner.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1-6 are rejected under 35 U.S.C. 102(b) as being anticipated by Nidou et al (JP 2001-320120 A).
- 5. In re claim 1, with reference to figure 6, Nidou et al disclose a semiconductor laser comprising a GaN-based semiconductor substrate (n mold GaN contact layer 62) and laminated layers (layers 64-71) formed on the GaN-based semiconductor substrate which include a GaN-based semiconductor clad layer (AlGaN cladding layer 65) containing Al and an active layer (barrier layer 67) formed thereabove, wherein the side surfaces of the laminated layers along the direction of the resonator of the semiconductor laser are inclined in such a direction that the resonator width is

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decreased from the GaN-based semiconductor substrate side to the upper portion of the laminated layers (figure 6 and Paragraph [0052]).

- 6. In re claim 2, Nidou et al disclose masks (63) are formed on the GaN-based semiconductor substrate (62) and the laminated layers (layers 64-71) are formed above the masks so that the side surfaces of the laminated layers along the direction of the resonator are from the grown surfaces of the semiconductor layers which have been selectively grown from the masks (Paragraph [0052]).
- 7. In re claim 3, Nidou et al disclose the end surfaces of the resonator of the semiconductor laser are cleavage planes of the GaN-based semiconductor substrate and the laminated layers (Paragraph [0064]).
- 8. In re claim 4, with reference to figure 8, Nidou et al disclose a semiconductor laser comprising a GaN-based semiconductor substrate (n mold GaN substrate 92) and laminated layers (layers 80-87) formed on the GaN-based semiconductor substrate which include a GaN-based semiconductor clad layer (AlGaN cladding layer 82) containing Al and an active layer (barrier layer 84) formed thereabove (Paragraph [0058]), wherein there are formed a pair of slots extending in the direction of the resonator of the semiconductor laser, and the active layer is formed in the region sandwiched between the pair of slots (figure 8).
- 9. In re claim 5, Nidou et al disclose the laser comprising masks (80) are provided on the bottom surfaces of the pair of slots, wherein the side surfaces of the slots are the grown surfaces of the semiconductor layers which have been selectively grown from the masks (figure 8).

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10. In re claim 6, Nidou et al disclose the pair of slots include exposed surfaces of the GaN-based semiconductor clad layer (AlGaN cladding layer 82) containing Al and the side surfaces of the slots are inclined in such a direction that the width between the slots is decreased from the GaN-based semiconductor substrate side to the upper portion of the laminated layers (figure 8).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Yuanda Zhang whose telephone number is 571-270-1439. The examiner can normally be reached on Monday-Thursday, Alternating Fri 8:30am-6:00p EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Minsun Harvey can be reached on 571-272-1835. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

YZ 06/11/07

> MINBUN OH HARVEY PRIMARY EXAMINER